

Surface Mount Fuses

Subminiature Surface Mount

NANO²® FUSE Very Fast-Acting 451/453 Series



The Nano² SMF Fuse is a very small, square surface mount fuse that is also available in a surface mount holder.

ELECTRICAL CHARACTERISTICS:

% of Ampere Rating	Ampere Rating	Opening Time
100%	1/16–15	4 hours, Minimum
200%	1/16–10	5 seconds, Maximum
	12–15	20 seconds, Maximum

AGENCY APPROVALS: Recognized under the Components Program of Underwriters Laboratories and Certified by CSA. Approved by METI from 1 through 5 amperes.

AGENCY FILE NUMBERS: UL E10480, CSA LR 29862.

INTERRUPTING RATINGS:

1/16 – 8A	50 amperes at 125 VAC/VDC 300 amperes at 32 VDC
10A	35 amperes at 125 VAC/50 amperes at 125 VDC 300 amperes at 32 VDC
12A – 15A	50 amperes at 65 VAC/VDC 300 amperes at 24 VDC

ENVIRONMENTAL SPECIFICATIONS:

Operating Temperature: –55°C to 125°C.

Shock: MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds).

Vibration: MIL-STD-202, Method 201 (10–55 Hz).

Salt Spray: MIL-STD-202, Method 101, Test Condition B.

Insulation Resistance (After Opening): MIL-STD-202, Method 302, Test Condition A, (10,000 ohms minimum).

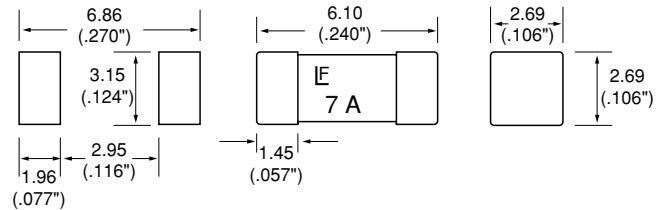
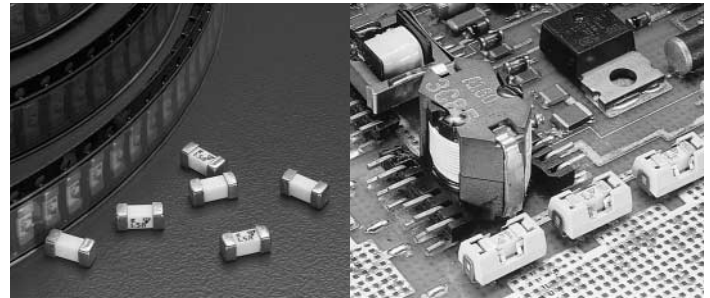
Resistance to Soldering Heat: MIL-STD-202, Method 210, Test Condition B (10 sec. at 260°C).

Thermal Shock: MIL-STD-202, Method 107, Test Condition B (–65 to 125°C).

Moisture Resistance: MIL-STD-202, Method 106, High Humidity (90–98 RH), Heat (65°C).

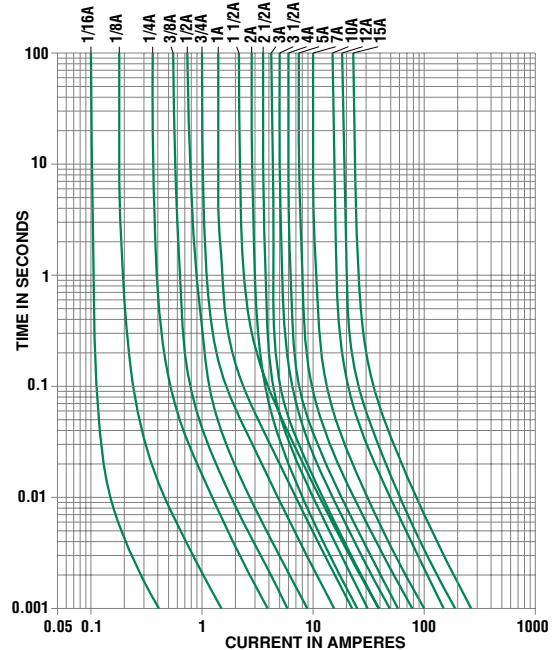
Tin-Lead Plated Catalog #	Silver Plated Catalog #	Ampere Rating	Voltage Rating	Nominal Resistance Cold Ohms	Nominal Melting I ² t A ² Sec.
—	R451.062	0.062	125	5.50	0.00019
—	R451.080	0.080	125	4.05	0.00033
—	R451.100	0.100	125	3.10	0.00138
—	R451.125	0.125	125	1.70	0.00286
R451.160	0453.160	0.160	125	1.80	0.00306
R451.200	0453.200	0.200	125	1.40	0.00652
R451.250	0453.250	0.250	125	1.05	0.01126
R451.315	0453.315	0.315	125	0.78	0.0231
R451.375	0453.375	0.375	125	0.610	0.0425
R451.400	0453.400	0.400	125	0.560	0.0484
R451.500	0453.500	0.500	125	0.420	0.0795
R451.630	0453.630	0.630	125	0.305	0.143
R451.750	0453.750	0.750	125	0.245	0.185
R451.800	0453.800	0.800	125	0.212	0.271
R451.001	0453.001	1.0	125	0.153	0.459
R451.1.25	0453.1.25	1.25	125	0.0780	0.664
R451.01.5	0453.01.5	1.5	125	0.0630	0.853
R451.01.6	0453.01.6	1.6	125	0.0580	1.060
R451.002	0453.002	2.0	125	0.0367	0.530
R451.02.5	0453.02.5	2.5	125	0.0286	1.029
R451.003	0453.003	3.0	125	0.0227	1.650
R451.3.15	0453.3.15	3.15	125	0.0215	1.920
R451.03.5	0453.03.5	3.5	125	0.0200	2.469
R451.004	0453.004	4	125	0.0160	3.152
R451.005	0453.005	5	125	0.0125	5.566
R451.06.3	0453.06.3	6.3	125	0.0096	9.17
R451.007	0453.007	7	125	0.0090	10.32
R451.008	0453.008	8	125	0.0077	20.23
R451.010	0453.010	10	125	0.0056	26.46
R451.012	0453.012	12	65	0.0049	47.97
R451.015	0453.015	15	65	0.0037	97.82

Refer to pg. 271 for SMF Omni-Blok® Holder, Series 154 000.



Recommended pad layout

Average Time Current Curves



PHYSICAL SPECIFICATIONS:

Materials: Body: Ceramic

Terminations: Tin-Lead Alloy or Silver Plated Caps.

Soldering Parameters:

Wave Solder — 260°C, 10 seconds maximum

Reflow Solder — 260°C, 30 seconds maximum

Solderability: MIL-STD-202, Method 208.

PACKAGING SPECIFICATIONS: 12mm Tape and Reel per EIA-RS481-1 (IEC 286, part 3); 1,000 per reel, add packaging suffix, MR; 5,000 per reel, add packaging suffix NR.

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